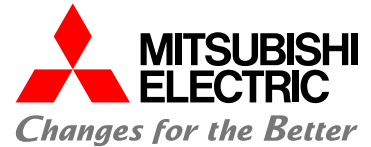


# PRESS CONFERENCE



**Tuesday, 9<sup>th</sup> of May 2023**

PCIM Europe, Messezentrum 1

90471 Nuremberg (Germany)

NCC Ost, Ebene 3, Room Shanghai

Press Kit /  
Content

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**// Agenda press conference**

**// Press releases**

- Mitsubishi Electric to Ship Samples of SBD-embedded SiC-MOSFET Module
- Mitsubishi Electric to Ship Samples of HV100 Dual-type X-Series HVIGBT Module
- Mitsubishi Electric to Construct New Wafer Plant to Boost SiC Power Semiconductor Business

**// Personal profile Dr. Masayoshi Takemi**

Executive Officer, Group President, Semiconductor & Device Group, Mitsubishi Electric Corporation, Japan

**// Personal profile Dr. Gourab Majumdar**

Senior Fellow, Semiconductor & Device Group, Mitsubishi Electric Corporation, Japan

**// Company profile**